



ACM SIGSOFT Distinguished Paper Award ICSE

**IEEE/ACM International Conference on
Software Engineering**

14 - 20 May 2023

Melbourne, Australia

Presented to

**Lyuye Zhang, Chengwei Liu, Zhengzi Xu, Sen
Chen, Lingling Fan, Lida Zhao, Jiahui Wu, and
Yang Liu**

For

**Compatible Remediation on Vulnerabilities
from Third-Party Libraries for Java Projects**

A handwritten signature in black ink, appearing to read 'John Grundy'.

John Grundy
General Chair

A handwritten signature in black ink, appearing to read 'Lori Pollock'.

Lori Pollock
Program Co-Chair

A handwritten signature in black ink, appearing to read 'Massimiliano Di Penta'.

Massimiliano Di Penta
Program Co-Chair